

# **4B3T U INTERFACE CIRCUIT**

#### PRELIMINARY DATA

- 4B3T TWO-WIRE U INTERFACE CIRCUIT FOR LT AND NT APPLICATION
- 120 kbaud LINE SYMBOL RATE (120 SYM-BOLS PER FRAME)
- SCRAMBLER AND DESCRAMBLER AC-CORDING TO CCITT REC V.29
- BARKER CODE (11 SYMBOLS) SYNCHRO-NIZATION WORD
- UNSCRAMBLED 1 KBIT/S HOUSEKEEPING CHANNEL
- ADAPTIVE ECHO CANCELLATION WITH TRANSVERSAL FILTERING
- ADAPTIVE DECISION FEEDBACK EQUALI-ZATION
- AUTOMATIC GAIN CONTROL
- PDM AD CONVERTER
- AUTOMATIC ACTIVATION AND DEACTIVA-TION WITH POLARITY ADAPTION
- AUTOMATIC CODE VIOLATION DETECTION
- POWER FEED UNIT CONTROL
- ADVANCED CL3 1.5µm CMOS PROCESS
- 28 PIN DUAL-IN-LINE PLASTIC PACKAGE
- V\* DIGITAL INTERFACE

#### SYSTEM OVERVIEW

STU2071 (UIC) provides two transparent 64 kbit/s B channels, a transparent 16 kbit/s D channel, a transparent 1 kbit/s service channel and a 1 kbit/s maintenance channel for loop and error messages on subscriber lines.

UIC enables full duplex continuous data transmission via the standard twisted pair telephone cable. Adaptive Echo cancellation is used to restore the received data. An equalizer, done with an adaptive filter, restores the data which are distorted by the transmission line.

The coefficient of the equalizer and echo canceller are conserved during a power down. An all digital PLL performs both bit and frame synchronization.

The analog front end consists of receive path RX and transmit path TX, providing a full duplex analog interfacing to the twisted pair telephone cable. Before data are converted to analog signals, they



pass through a digital filter (TX-filter) to reduce the high frequency components. After D/A conversion the signal is amplified and sent to the hybrid.

The received signal is converted back to digital data and passed through the RX matching filter to restore the line signal. The A/D convertor is a second order sigma/delta modulator which operates with a clock of 15.36 MHz. After timing recovery, achieved by a digital PLL, the received signal is equalized, in an adaptive digital filter, to correct for the frequency and group delay distortion of the line.

Power supply status can be read via PFOFF. The UIC can disable its power supply (DISS), and two relay drivers outputs are provided (accessible via B2\*) to control the power feed unit (RD1,RD2).

#### **PIN CONNECTION** (Top view)



Figure 1: UIC Schematic Block Diagram



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### **PIN DESCRIPTION**

Pin	Name	Function
1	DVSS(input)	Digital Ground.
2	PFOFF(input)	Power feed off. PFOFF=HIGH is coded by the A-bit indication HI accessible on DOUT. Active in LT mode only.
3	LT(input)	LT/NT mode selection.
4	TEST(input)	Test Mode.
5	DISS(output)	A bit channel driven pin. Active in LT mode only.
6	RESETN(input)	Hardware Reset.
7	DIN(input)	Digital interface input.
8	TSP(input)	Transmit single pulse. 1 KHz single pulse alternating positive and negative polarity is transmitted.
9	BURST(input)	Burst mode selection. Active in LT mode only.
10	FR(in/out)	8KHz Digital interface frame clock; input in LT and output in NT mode.
11	DOUT(output)	Digital interface output.
12	CL(in/out)	Digital interface bit clock; input in LT and output in NT mode.
13	RD1(output)	Power feeder relay driver.
14	RD2(output)	Power feeder relay driver.
15, 16, 17	S2,S1,S0	Time slot pin strap (. Active in LT mode only.
18	DVDD(input)	5V +/-5% positive digital power supply.
19	AVSS(input)	Analog Ground.
20	LOUT1(output)	Output to the line.
21	AVDD(input)	5V +/-5% positive analog power supply.
22	AGND(input)	Analog Ground.
23	LOUT2(output)	Output to the line.
24,25	LIN1,LIN2(input)	Inputs from the line (UK0).
26, 27	XTAL1,XTAL2(inputs)	System clock input; nominal frequency is 15.36MHz.
28	CLS(output)	Clock output synchronous to the line receive clock at 7.68MHz.

# **APPLICATION AND MODES**

The UIC can be used in LT, LT-burst and in NT mode.

Hereafter a list of the pin bias to set up the desired mode is given.

In LT mode:

Pins	Value
LT	1
BURST	0
S0	0
S1	0
S2	0

In LT burst:	
Pins	Value
LT	1
BURST	1
SO	time slot
S1	time slot
S2	time slot

In NT:	
Pins	Value
LT	0
BURST	0
SO	0
S1	0
S2	1

Test pins should always be tied to GND



#### MODE DEPENDENT FUNCTIONS

				MODE		
F	PIN	LT burst	NT	LT	LTRP	NTRP
LT	input	1	0	1	0	0
BURST	input	1	0	0	0	0
S2, S1, S0	input	static	100	000	001	010
DIN DOUT	input output	2048 kbit/s	256 kbit/s	256 kbit/s	256 kbit/s	256 kbit/s
CLS (MHz)	output	7.68	7.68	7.68	_	7.68
CL (KHz)	input output	4096 -	_ 512	512 -	512 -	_ 512
FR (KHz)	input output	8	_ 8	8	8	- 8

## **RECOMMENDED APPLICATIONS**

LT mode

#### Figure 2: LT Schematic Application Diagram



DIN:	Data input, datarate = 256 kbit/s, continuous
DOUT:	Data output, datarate = 256 kbit/s, continuous
CL:	Data clock input, f = 512 KHz
FR:	Frame clock input, f = 8 KHz (1:1)
XTAL2:	System clock input, f = 15.36 MHz (Tx clock synchronous to system clock)
CLS:	Clock output, 7.68 MHz



# NT mode

CLS:









### LT burst mode

Figure 4: LT Burst Mode Schematic Application Diagram.





### Figure 5: Repeater Block Diagram.





#### **DIGITAL INTERFACE**

UIC is provided with a digital serial interface, named V\*, which operates in two modes.

In Fig. 6 the frame format for both modes is shown.

The base frame consists of:

- B1 : 64 kbit/s transparent data channel
- B2 : 64 kbit/s transparent data channel
- B2\* : Monitor channel
- B1\*: 8 bits so set

D1/D2 : 16 kbit/s D channel

- A1..A4 : Command/Indicate channel
- T : Transparent service channel
- E : Extension bit

In Fig. 7 and 8 the timings in Continuous and in

Figure 6: V\* Frame Format.

Burst mode are given.

B2\* available messages (do not use in REPETER modes):

Code	Function
74H	Set RD1 to HIGH
75H	Set RD2 to HIGH
76H	Set RD1 and RD2 to HIGH
77H	Reset RD1 and RD2 to LOW
EFH	Reset frame error counter
(F0-FF)H	NOD
All others	Not defined

In Fig. 7 and 8 the timings in Continuous and in Burst mode are given.



Figure 7: Continuous Mode.

Signal					}		CONTIN	iuous i	IODE							
CL: 512 KHz FR: 8 KHz	пп	ΠΠ	ЛЛ	лл		ЛЛ	лл	лл	nn.	лл			<b>.</b>	nn	nn	nп
DIN: 256 KBN/s DOUT: 256 KBN/s		I				I T	I		I							
Bit no.	4	5	6	7	0	1	2	3	4	5	6	7	0	1	2	

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#### Figure 8: Burst Mode.



# LINE FRAME STRUCTURE.

The information flow across the subscriber line

uses the frame structure here below. The length of one frame corresponds to 120 ternary symbols being transmitted within 1 ms.

								•					
1	2	3	4	5	6	7	8	9	10	11	12		
T1	T1	T1	T1	T1	T1								
T1	T1	T1	T1	T1	T1	24							
T1	T1	T1	T2	T2	T2	T2	T2	T2	T2	T2	T2	36	
T2	T2	T2	T2	T2	T2	48							
T2	T2	T2	T2	T2	T2	T3	Т3	Т3	Т3	Т3	Т3	60	$LT \Rightarrow NT$
Т3	Т3	Т3	Т3	Т3	Т3	72							
Т3	Т3	Т3	T4	T4	T4	84							
T4	T4	T4	T4	T4	T4	96							
T4	T4	T4	T4	T4	T4	108							
T4						SW1						120	
1	2	3	4	5	6	7	8	9	19	11	12		
T5	T5	T5	T5	T5	T5								
T5	T5	T5	T5	T5	T5	24							
M2	T5	T5	T5	T6	T6	T6	T6	T6	T6	T6	T6	36	
T6	T6	T6	T6	T6	T6	48							
Т6						SW2						60	$NT \Rightarrow IT$

Τ7

Τ7

Τ7

Τ8

Τ8

Τ7

Τ7

Τ7

Τ8

Τ8

T7

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Τ7

Τ8

Τ8

T8

Τ7

Τ7

T8

Т8

Т8

72

84

96

108

120

 $\mathsf{NT} \Rightarrow \mathsf{LT}$ 

Agenda:

T6

Τ7

Τ7

Τ8

Τ8

T6

Τ7

Τ7

Τ8

T8

T6

Τ7

Τ7

Т8

Т8

Т1Т8	B + B + D - Data (ternary)
M1, M2	Service Data (ternary)
SW1, SW2	Synchronizing Word

Τ6

Τ7

Τ7

Т8

Т8

Τ6

Τ7

Τ7

Τ8

Τ8

Τ6

Τ7

Τ7

Τ8

Т8



#### Maintenance and service channel.

The ternary symbols M1 and M2 represent nonscrambled data that can be transmitted at a rate of 1 kBaud. Those symbols are used for various purposes:

- Maintenance Channel (control test loops (LT  $\rightarrow$  NT) and frame errors (LT  $\rightarrow$  NT)
- Service channel (transparent user data and

#### COMMAND / INDICATE CHANNEL (A bits)

Command/Indicate codes are define depending on the mode selected (LT or NT).

#### NT mode COMMANDS (DIN)

transmit messages from NT to LT)

#### Encoding.

The encoding of a binary bit stream is made such that 4 binary bits correspond to 3 symbols of ternary symbol stream. The encoding follows the rules of modified monitoring state 43 (MMS43).

	· · ·	
ACT	1000	Activate. Layer 1 is activated at the UK0 interface starting with a 'wake-up' signal INFO U1W, followed by INFO U1A during synchronization and closed by INFO U1 when synch is gained.
AW	0000	Awake. Set the module interface from the power-down to the power-up state. No signal is emitted at UK0 interface. Even DIN pin pulled LOW can have the same effect.
DC	1111	Deactivation confirmation. The module interface is deactivated. The transmitter is disabled but the receiver is still enabled to recognize an awake signal. THe UIC is set in power down state.
RES	1101	Reset. Reset the UIC to the initial state.
SY	1100	Synchronize. Drive the UIC in connect through from module interface to line interface.

Remark: Executing the command RES (1101) is functionally equivalent to pulling the RESETN pin (6) LOW, with one exception:

a) RES command set pin DISS to HIGH (+5V)

b) pulling RESETN LOW set pin DISS to LOW (0V).

#### NT mode INDICATION (DOUT)

ACT	1000	Activate. The synchronous state of the receiver is reached.
DC	1111	Deactivation confirmation. The transmitter is disabled but the receiver remains enabled to detect awake signals at UK0 UIC is set in power down state.
DEAC	0000	Deactivate. A request to deactivate INFO U0 has been detected.
СТ	1100	Connection Through. The UIC is fully activated.
CTL2	1110	Connection through with loop 2. A loop 2 command has been detected at UK0.
L2	1010	Loop 2. Synchronization has been reached during a Loop 2 activation procedure.
RSYN	0100	Resynchronization. The receiver has lost framing and is attempting to resynchronize.



#### LT mode COMMANDS (DIN)

ACT	1000	Activate. UIC is set in power-up state, executing the complete activation of Layer 1. The transparent channel transmission is enabled.
AL	1001	Analog Loop. The analog transmitter output is looped back to the receiver input which is disconnected from UK0 interface. A pseudo wake-up procedure is executed.
L2	1010	Loop 2. Command to close Loop 2 in NT.
LTD	0011	Line Transmission Disabled. UIC stops transmitting signals on the line and is powered down.
DEAC	0000	Deactivate. Request to deactivate UK0.
RES	1101	Reset. Reset the UIC to the initial state.
SSP	0101	Send Single Pulse. The UIC transmits single pulse at 1 ms time intervals with alternate polarity.
L4	1011	Repeter loop

LT mode INDICATION (DOUT)

	<u> </u>	
ACT	1000	Activation running. UIC is powered-up and the activation procedure is running.
RDS	0111	Running Digital Sum. Given during activation procedure. The receiver has reached synchronization.
СТ	1100	Connection Through. Layer 1 activation procedure has been completed. B and D channels are transparently connected.
DEAC	0001	Deactivation running. UIC is deactivating in response of a DEAC, RES or LTD command.
DC	1111	Deactivation confirmation. UIC has completed the deactivation procedure.
RSYN	0100	Resynchronization. The receiver has lost framing and is attempting to resynchronize.
HI	0011	High Impedance. When pin PFOFF is HIGH indication HI is output and UIC starts transmitting INFO U0. Normally used to indicate that remote feeding has been switched off.

#### POWER DOWN STATE

Power consumption of most functions is reduced; module interface is not active; C/I messages cannot be exchanged.

#### **ACTIVATION DEACTIVATION**

The ACTIVATION procedure consists of three steps: AWAKE, SYNCHRONIZE and CONNECT THROUGH.

Activation times are (max):

COLDSTART 1 sec WARMSTART 170 msec

The DEACTIVATION procedure consists of two steps: line DEACTIVATION and POWER DOWN. Deactivation time is (typ) 4 ms.

#### OSCILLATOR

Oscillators of 15.36 MHz are required. When in NT a tollerances of +/-30 ppm is allowed, it is advisable to use in LT a tollerances of +/-20 ppm.

#### LINE RANGE

The LINE RANGE depends on the cable section. Typically:

up to 4.2Km with 0.4mm cable

- 5.5Km 0.5mm -
- 8.0Km 0.6mm -

Assumed noise level for such performances is 10uV/SQRT(Hz) on a 200KHz bandwidth.

#### LT CLOCK JITTER

The phase jitter between Master Clock (15.36MHz) and interface clock (4.096MHz) should not exceed 50ns.



# **ELECTRICAL CHARACTERISTICS**

Supply Voltages: DVDD = 5V +/-5% AVDD = 5V +/-5% AGND = 2.5V +/-5% (max curr 0.25mA) Power consumption Active = max 280mW (line loaded at 150Ohm) Power down = Typ. 30mW = Max. 50mW

# DIGITAL INTERFACE STATIC CHARACTERISTICS

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
VIH	High Level Input Voltage		3.5			V
VIL	Low Level Input Voltage				1.0	V
V <sub>OH1</sub>	High Level Output Voltage all outputs except DOUT	I <sub>OH1</sub> = 0.4mA	V <sub>DD</sub> - 0.66			V
V <sub>OH2</sub>	High Level Output Voltage DOUT, (Open Drain)	R to $DV_{DD}$ R = 1K $\Omega$	4			V
V <sub>OL1</sub>	Low Level Output Voltage all outputs except DOUT	$I_{OL1} = 0.4 mA$			0.33	V
V <sub>OL2</sub>	Low Level Output Voltage DOUT, (Open Drain)	I <sub>OL1</sub> = 0.7mA			0.4	V
C <sub>IN</sub>	Inputs Capacitance, all inputs at DOUT if output is off				10 10	pF pF
Cout	Load Capacitance at all outputs except at DOUT				25	pF
Солт	Load Capacitance at DOUT				150	рF
I <sub>IN</sub>	Input Leakage Current				1	μA



# DIGITAL INTERFACE DYNAMIC CHARACTERISTICS Burst mode.

				С	onditions		
Parameter	Port	from	to	С	R to DVDD	Min.	Max.
				рF	KΩ	ns	ns
Rise Time tr Fall Time tf	FR, CL FR, CL	1.0V 3.5V	3.5V 1.0V	10 10			30 30
Setup Time ts Setup Time ts Setup Time ts Setup Time ts	FR FR DIN MPF	FR, i – FR, i + DIN +/– MPF +/–	CL, i + CL, i + CL, i + CL, i +			30 30 50 50	
Hold Time th Hold Time th Hold Time th Hold Time th	FR FR DIN MPF	CL, i + CL, i + CL, i + CL, i +	FR, i – FR, i + DIN +/– MPF +/–			50 50 60 60	
Delay Time td Delay Time td	DOUT DOUT	CL, i – CL, i –	DOUT +/ DOUT +/	50 150	1 1	0 0	150 200
Clock Width tc Clock Width tc	CL, i CL, i	CL +/- CL +/-	CL +/- CL -/+			239 100	249 144

+ = rising edge

- = falling edge





# DIGITAL INTERFACE DYNAMIC CHARACTERISTICS (continued) **Continuous mode.**

	Conditions						
Parameter	Port	from	to	С	R to DVDD	Min.	Max.
				pF	KΩ	ns	ns
Rise Time tr Fall Time tf	FR, CL, i FR, CL, i	1.0V 3.5V	3.5V 1.0V	10 10			30 30
Rise Time tr Fall Time tf	FR, CL, o FR, CL, o	10% 90%	90% 10%	25 25			30 30
Setup Time ts Setup Time ts Delay Time td Hold Time th Hold Time th Delay Time td	DIN MPF FR DIN MPF DOUT	DIN +/- MPF +/- CL, i + CL, i - CL, i - CL, i +	CL, i + CL, i + FR, i + DIN +/- DIN +/- DOUT +/-	25	10	50 50 -200 100 100	200 500
Setup Time ts Setup Time th Delay Time td Delay Time td	DIN DIN DOUT FR	DIN +/-1 CL, o - CL. o + CL, o +	CL, o + DIN +/- DOUT +/- FR,o +	25 25	10	50 100 -150	500 150
Clock Width tc Clock Width tp Pulse Width tp Pulse Width tp	CL, i CL, i CL, i CL, i	CL +/- CL +/- CL +/- CL +/-	CL +/- CL +/- CL -/+ CL -/+	25 25		1830 1830 850 850	2080 2080 1100 1100

+ = rising edge

- = falling edge



# DIGITAL INTERFACE DYNAMIC CHARACTERISTICS (continued) Master clock.

				C	onditions		
Parameter	Port	from	to	С		Min.	Max.
				рF		ns	ns
Rise Time tr Fall Time tf	XTAL2 XTAL2	1.0V 3.5V	3.5V 1.0V	10 10			15 15
Rise Time tr Fall Time tf	CLS CLS	10% 90%	90% 10%	25 25			15 15
Pulse Width	CLS	CLS +/-	CLS -/+	25		20	

+ = rising edge

- = falling edge

Setup Time ts Hold Time th Delay min. td Delay max. td	DIN, FR, i +/- CL, i + CL, i + CL, i - CL, i + CL, i -	2.5V 2.5V 2.5V 2.5V 2.5V	CL, i + DIN, FR, i +/- DOUT +/- DOUT +/-	2.5V 2.5V 0.4 / 4V 4 / 0.4V
Delay min. td (negative) Delay max. td	CL, i + CL, i +	2.5V 2.5V	FR, i + FR, i +	3.5V 1V
Setup Time ts Hold Time ts Delay max. td Delay min. td (negative) Delay max. td	DIN, +/- CL, o + CL, o + CL, o + CL, o +	2.5V 2.5V 2.5V 2.5V 2.5V	CL, o + DIN +/- DOUT +/- FR, o + FR, o +	2.5V 2.5V 4 / 0.4V 0.33V VDD - 0.66V
Pulse Width tp Clock Width tc	CL, o +/- CL, o +/-	2.5V 2.5V	CL, o –/+ CL, o +/–	2.5V 2.5V
Pulse Width tp Clock Width tc	CLS, MXCL +/- CLS, MXCL +/-	2.5V 2.5V	CL, o -/+ CL, o +/-	2.5V 2.5V



# **DIP28 PACKAGE MECHANICAL DATA**

ЫМ		mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
a1		0.63			0.025		
b		0.45			0.018		
b1	0.23		0.31	0.009		0.012	
b2		1.27			0.050		
D			37.34			1.470	
E	15.2		16.68	0.598		0.657	
е		2.54			0.100		
e3		33.02			1.300		
F			14.1			0.555	
1		4.445			0.175		
L		3.3			0.130		



ЫМ		mm		inch			
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	12.32		12.57	0.485		0.495	
В	11.43		11.58	0.450		0.456	
D	4.2		4.57	0.165		0.180	
D1	2.29		3.04	0.090		0.120	
D2	0.51			0.020			
E	9.91		10.92	0.390		0.430	
е		1.27			0.050		
e3		7.62			0.300		
F		0.46			0.018		
F1		0.71			0.028		
G			0.101			0.004	
М		1.24			0.049		
M1		1.143			0.045		

# PLCC28 PACKAGE MECHANICAL DATA



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